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CONFIRMATION NO. 4215

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SERIAL NUMBER 10/782,270	FILING DATE 02/18/2004  RULE	CLASS 257	GROUP ART UNIT 2815	ATTORNEY DOCKET NO. 2269-4973.1US (00-0593.01)
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## APPLICANTS

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## \*\* CONTINUING DATA \*\*\*\*\*

This application is a CON of 10/150,902 05/17/2002

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

SINGAPORE 200201301-9 03/04/2002

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 05/13/2004

Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no	STATE OR  COUNTRY SINGAPORE	SHEETS  DRAWING 18	TOTAL  CLAIMS 26	INDEPENDENT  CLAIMS 2
35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance				
Verified and Acknowledged	Examiner's Signature <i>[Signature]</i>	Initials <i>[Initials]</i>		

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## TITLE

Interposer substrate and wafer scale interposer substrate member for use with flip-chip configured semiconductor dice

FILING FEE  RECEIVED 878	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:	<input type="checkbox"/> All Fees
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